TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TC74HC07AP, TC74HC07AF

HEX BUFFER (OPEN DRAIN)

The TC74HC07A is a high speed CMOS BUFFER fabricated with silicon gate C2MOS technology.

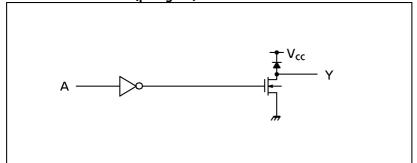
It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation. Pin configuration and function are the same as the TC74HCT7007A. But the TC74HC07A has high performance MOS N-channel transistor (OPEN-DRAIN) outputs. This device can, therfore, with a suitable pull-up resistors,

be used in wired - AND, LED driver and other applications.
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

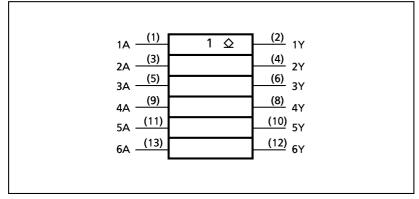
FEATURES:

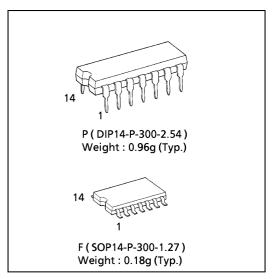
- High Speed······ $t_{pz} = 5ns(typ.)$ at $V_{CC} = 5V$
- Low Power Dissipation ·············· $I_{CC} = 1 \mu A(Max.)$ at Ta = 25°C
- High Noise Immunity $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (Min.)
- Output Drive Capability 10 LSTTL Loads
- Wide Operating Voltage Range ···· V_{CC} (opr.) = 2V~6V
- Open Drain Structure.
- Pin and Function Compatible with 74LS07

SYSTEM DIAGRAM (per gate)

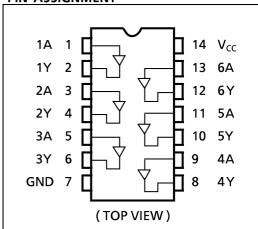


IEC LOGIC SYMBOL

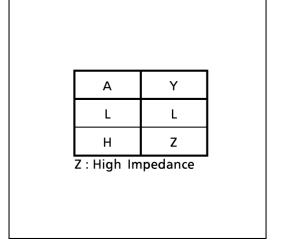




PIN ASSIGNMENT



TRUTH TABLE



ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage Range	V _{cc}	− 0.5~7	V
DC Input Voltage	V _{IN}	−0.5~V _{CC} + 0.5	٧
DC Output Voltage	V _{OUT}	$-0.5 \sim V_{CC} + 0.5$	V
Input Diode Current	I _{IK}	± 20	mA
Output Diode Current	I _{OK}	± 20	mA
DC Output Current	I _{OUT}	± 25	mA
DC V _{CC} / Ground Current	I _{cc}	± 50	mA
Power Dissipation	P _D	500 (DIP)* / 180 (SOP)	mW
Storage Temperature	T _{stg}	−65~150	°C

^{*500}mW in the range of Ta= $-40^{\circ}\text{C}\sim65^{\circ}\text{C}$. From Ta=65°C to 85°C a derating factor of $-10\text{mW}/^{\circ}\text{C}$ shall be applied until 300mW.

RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage	V _{CC}	2~6	\ \
Input Voltage	VIN	0∼V _{cc}	V
Output Voltage	V _{OUT}	0~V _{cc}	V
Operating Temperature	T _{opr}	−40~85	°C
Input Rise and Fall Time	t _r , t _f	$0 \sim 1000 (V_{CC} = 2.0V)$ $0 \sim 500 (V_{CC} = 4.5V)$ $0 \sim 400 (V_{CC} = 6.0V)$	ns

DC ELECTRICAL CHARACTERISTICS

PARAMETER SYMBOL TEST CONDITION		TEST CONDITION		V _{CC}	Ta = 25°C			Ta = −40~85°C		UNIT
		(V)	MIN.	TYP.	MAX.	MIN.	MAX.	UNIT		
High - Level Input Voltage	VIH			2.0 4.5 6.0	1.50 3.15 4.20	111	=	1.50 3.15 4.20	_ _	\ \
Low - Level Input Voltage	V _{IL}			2.0 4.5 6.0			0.50 1.35 1.80	_ _ _	0.50 1.35 1.80	٧
Low - Level Output Voltage	V _{OL}	V _{IN} = V _{IL}	$I_{OL} = 20 \mu A$	2.0 4.5 6.0	_ _ _	0.0 0.0 0.0	0.1 0.1 0.1	_ _ _	0.1 0.1 0.1	\ \
			$I_{OL} = 4$ mA $I_{OL} = 5.2$ mA	4.5 6.0	-	0.17 0.18	0.26 0.26	_	0.33 0.33	
Output Off - State Current	l _{oz}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC}$		6.0	_	_	± 0.5	_	± 5.0	
Input Leakage Current	I _{IN}	$V_{IN} = V_{CC}$ or GND		6.0	_	_	± 0.1	_	± 1.0	μ A
Quiescent Supply Current	I _{CC}	$V_{IN} = V_{CC}$ or GND		6.0	_	_	1.0	_	10.0	

AC ELECTRICAL CHARACTERISTICS ($C_L = 15pF$, $V_{CC} = 5V$, $Ta = 25^{\circ}C$, Input $t_r = t_f = 6ns$)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Output Transition Time	t _{THL}		_	4	8	
Propagation Delay Time	t _{pLZ}	$R_L = 1k\Omega$	_	5	15	ns
Propagation Delay Time	t _{pZL}	$R_L = 1k\Omega$	_	5	15	

AC ELECTRICAL CHARACTERISTICS ($C_L = 50 pF$, Input $t_r = t_f = 6 ns$)

PARAMETER	SYMBOL	TEST CONDITION		Ta = 25°C		-	$Ta = -40 \sim 85^{\circ}C$		UNIT
FARAIVIETER			$V_{CC}(V)$	MIN.	TYP.	MAX.	MIN.	MAX.	וואוטן
			2.0	_	30	75	_	95	
Output Transition Time	t _{THL}		4.5	_	8	15	_	19	
			6.0		7	13	_	16	
			2.0	_	10	90	_	115	
Propagation Delay Time	t _{pLZ}	$R_L = 1k\Omega$	4.5	_	7	18	_	23	ns
			6.0	_	6	15	_	20	
Propagation Delay Time	t _{pZL}	$R_L = 1k\Omega$	2.0	_	17	90	_	115	
			4.5	_	7	18	_	23	
		_	6.0	_	5	15	_	20	
Input Capacitance	C _{IN}			_	5	10	_	10	
Output Capacitance	C _{OUT}			_	3	_	_	_	pF
Power Dissipation Capacitance	C _{PD} (1)			_	4	_	_	_	

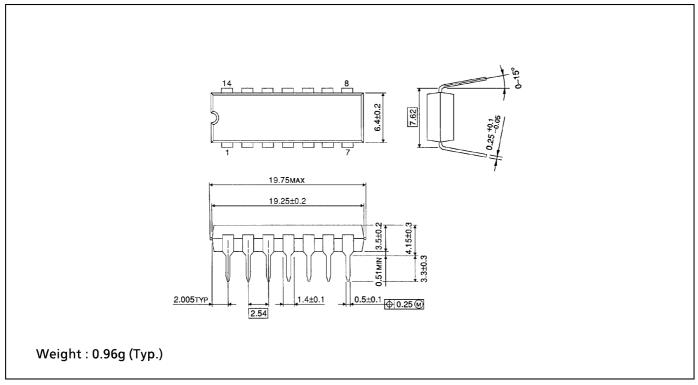
Note (1) C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 I_{CC} (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 6$ (per Gate)

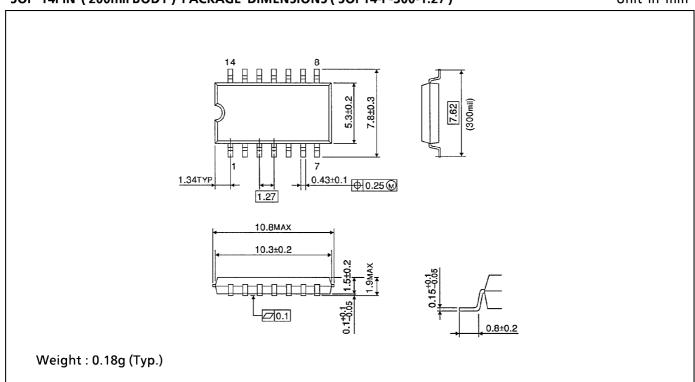
DIP 14PIN PACKAGE DIMENSIONS (DIP14-P-300-2.54)

Unit in mm



SOP 14PIN (200mil BODY) PACKAGE DIMENSIONS (SOP14-P-300-1.27)

Unit in mm



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